#### **General Description**

The MAX4735 quad-SPDT switch routes audio signals in portable applications. Each channel has a  $0.31\Omega$  typical on-resistance, allowing the MAX4735 to drive  $8\Omega$  loudspeakers with less than 0.02% distortion.

The MAX4735 is configured as a quad-SPDT switch with two common control inputs. Each digital input controls two pairs of SPDT switches. The switches are fully bidirectional, allowing both multiplexing and demultiplexing operation. Break-before-make operation is guaranteed.

The device operates from a +1.6V to +3.6V supply and over the extended  $-40^{\circ}C$  to  $+85^{\circ}C$  temperature range. It is offered in both 16-pin 3mm x 3mm TQFN and TSSOP packages.

#### Applications

**Features** 

- ♦ Low 0.31Ω RoN
- 0.06Ω On-Resistance Flatness
- Excellent 0.015Ω On-Resistance Matching
- Low 0.02% THD into 8Ω
- Low 0.015% THD into 32Ω
- Audio Signal Routing
- Space-Saving, 3mm x 3mm TQFN Package
- ♦ 1.8V Logic Compatible

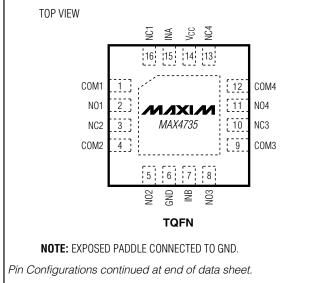
Cell Phones Digital Still Cameras PDAs and Palmtop Devices MP3 Players

#### **Ordering Information**

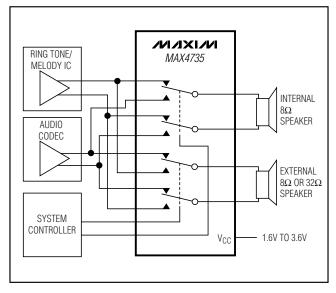
PART	PIN-PACKAGE	TOP MARK	PKG CODE	
MAX4735ETE	16 TQFN	ACT	T1633-4	
MAX4735EUE	16 TSSOP	_	U16-2	

**Note:** All products specified across the -40°C to +85°C temperature range.

# \_\_\_Pin Configurations



#### **Typical Application Circuit**



M / X / M

\_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

#### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> , INA, INB to GND	0.3V to +4.0V
All Other Pins to GND (Note 1)	0.3V to (V <sub>CC</sub> + 0.3V)
Continuous Current (NO_, NC_, COM_)	
Peak Current (NO_, NC_, COM_)	
(pulsed at 1ms, 50% duty cycle)	±400mA
Peak Current (NO_, NC_, COM_)	
(pulsed at 1ms, 10% duty cycle	±500mA

Note 1: Signals on NO\_, NC\_, COM\_ exceeding V<sub>CC</sub> or GND are clamped by internal diodes. IN\_ is clamped to GND by an internal diode. Limit forward-diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = 2.7V \text{ to } 3.6V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = 3V, T_A = +25^{\circ}C.)$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS			ТҮР	MAX	UNITS	
POWER SUPPLY		•		•			•	
Supply Voltage Range	V <sub>CC</sub>					3.6	V	
Supply Current	ICC	$V_{CC} = 3.6V, V_{IN} = 0 \text{ or } V_{C}$ COM_ = floating		0.015	1	μA		
ANALOG SWITCH								
Analog Signal Range		NO_, NC_, COM_		0		V <sub>CC</sub>	V	
	Davi	$V_{CC} = 2.7V,$ $I_{COM} = 100mA,$	$T_A = +25^{\circ}C$		0.31	-		
On-Resistance	R <sub>ON</sub>	$V_{NO}$ or $V_{NC}$ = 0 to $V_{CC}$ (Note 3)	$T_A = T_{MIN}$ to $T_{MAX}$			0.45	Ω	
On-Resistance Match	ΔRon	$V_{CC} = 2.7V,$ $I_{COM} = 100mA,$ $V_{NO}$ or $V_{NC} = 1.5V$ (Notes 3, 4)	$T_A = +25^{\circ}C$		0.015	0.03	- Ω	
			$T_A = T_{MIN}$ to $T_{MAX}$			0.03		
On-Resistance Flatness	-	$V_{CC} = 2.7V;$ $I_{COM} = 100mA; V_{NO}$ or	T <sub>A</sub> = +25°C		0.06	0.75		
	R <sub>FLAT</sub>	V <sub>NC</sub> = 0.6V, 1.2V, 1.8V (Note 5)	$T_A = T_{MIN}$ to $T_{MAX}$			0.080	Ω	
NO_ or NC_ Off-Leakage	IO or NC Off-I eakage		$T_A = +25^{\circ}C$	20		20		
Current	loff	$V_{COM}$ = 3V, 0.3V or floating; $V_{NO}$ or $V_{NC}$ = 0.3V, 3V or floating	$T_A = T_{MIN}$ to $T_{MAX}$	100		100	– nA	
COM_ On-Leakage	kage	V <sub>CC</sub> = 3.3V; V <sub>NO</sub> or V <sub>NC</sub> = 0.3V, 3V	$T_A = +25^{\circ}C$	20		20	24	
Current	ION	or floating; $V_{COM} = 0.3V$ , $3V$ or floating	$T_A = T_{MIN}$ to $T_{MAX}$	100		100	- nA	

#### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{CC} = 2.7V \text{ to } 3.6V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = 3V, T_A = +25^{\circ}C.)$  (Note 2)

PARAMETER	SYMBOL	CONDIT	MIN	ТҮР	MAX	UNITS		
DYNAMIC CHARACTERIS	STICS	•						
Turn-On Time	ton	$V_{CC} = 2.7V,$ $V_{NO}$ or $V_{NC} = 1.5V,$	T <sub>A</sub> = +25°C		40	200	ns	
	LOIN	$R_L = 50\Omega$ , $C_L = 35pF$ , Figure 1	$T_A = T_{MIN}$ to $T_{MAX}$			200	115	
Turn-Off Time		$V_{CC} = 2.7V,$ $V_{NO}$ or $V_{NC} = 1.5V,$	T <sub>A</sub> = +25°C		20	180	ns	
	toff	$R_L = 50\Omega$ , $C_L = 35pF$ , Figure 1	$T_A = T_{MIN}$ to $T_{MAX}$			180	115	
Break-Before-Make Time	t <sub>BBM</sub>	$V_{CC} = 2.7V,$ $V_{NO}$ or $V_{NC} = 1.5V,$	T <sub>A</sub> = +25°C	2	15			
Diear-Deloie-Iviare Time	rbbw	$R_L = 50\Omega$ , $C_L = 35pF$ , Figure 2 (Note 6)	$T_A = T_{MIN}$ to $T_{MAX}$	2			ns	
Charge Injection	Q	$V_{GEN} = 0V, R_{GEN} = 0\Omega, C_L = 1nF, Figure 3$			100		рС	
On-Channel Bandwidth -3dB	BW	$R_L = 50\Omega$ , Figure 4		20		MHz		
Off-Isolation	V <sub>ISO</sub>	$V_{COM}$ = 1 $V_{RMS}$ , $R_{L}$ = 50 $C_{L}$ = 5pF, Figure 4 (Note		-66		dB		
Crosstalk	V <sub>CT</sub>	$V_{COM}$ = 1 $V_{RMS}$ , $R_{L}$ = 50 $C_{L}$ = 5pF, Figure 4 (Note			-86		dB	
Total Harmonic Distortion Plus Noise	THD+N	f = 20Hz to 20kHz; $V_{NC_{-}}$ , $V_{COM_{-}}$ = 0.5V <sub>P-P</sub> ; $R_{L}$ = 32	—		0.02		%	
NC_ or NO_ Off- Capacitance	C <sub>NC_(OFF</sub> ), C <sub>NO_(OFF</sub> )	f = 1MHz, V <sub>NO</sub> = V <sub>NC</sub> = Figure 5	= V <sub>COM</sub> _ = 1.5V,		70		pF	
COM_ On-Capacitance	C <sub>COM</sub> (ON)	f = 1MHz, $V_{NO_{-}} = V_{NC_{-}} =$ Figure 5	= V <sub>COM</sub> _ = 1.5V,		250		pF	
Power-Supply Rejection Ratio	PSRR	$V_{AC} = 100mV_{P-P}, V_{COM} = 1.5V, R_L = 50\Omega,$ f = 100kHz			-34		dB	
DIGITAL INPUTS (INA,							-	
Input-Logic High	VIH			1.4			V	
Input-Logic Low	VIL					0.5	V	
Input Leakage Current	liN	$V_{IN} = 0 \text{ or } V_{CC}$				±200	nA	

Note 2: Devices are 100% tested at  $T_A = +85^{\circ}C$ . Limits across the full temperature range are guaranteed by design and correlation. Note 3: RON and RON matching specifications are guaranteed by design for MAX4735ETE only.

**Note 4:**  $\Delta R_{ON} = R_{ON}(MAX) - R_{ON}(MIN)$ .

Note 5: Flatness is defined as the difference between the maximum and minimum value of on-resistance, as measured over the specified analog signal ranges.

Note 6: Guaranteed by design, not production tested.

Note 7: Off-isolation = 20log10 [V<sub>COM</sub> / (V<sub>NO</sub> or V<sub>NC</sub>)], V<sub>COM</sub> = output, V<sub>NO</sub> or V<sub>NC</sub> = input to off switch.

Note 8: Between any two switches.

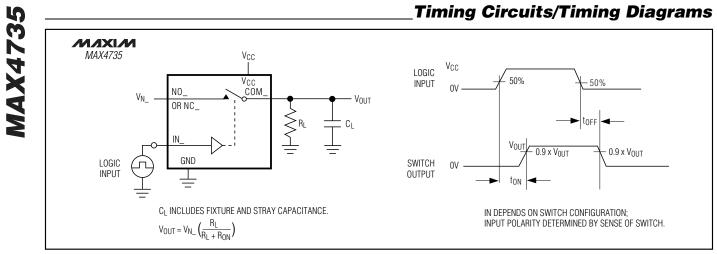


Figure 1. Switching Time

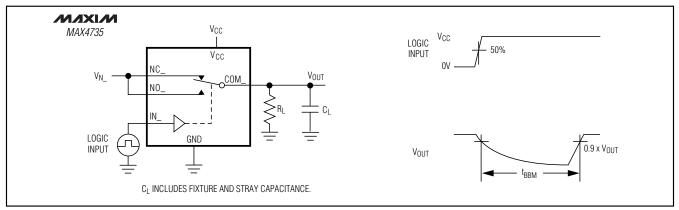


Figure 2. Break-Before-Make Interval

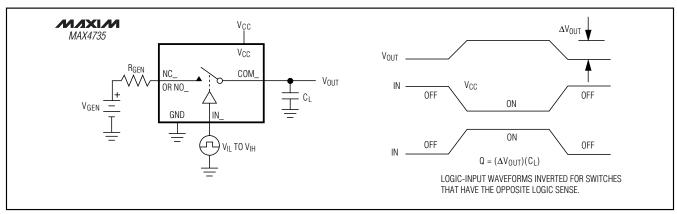
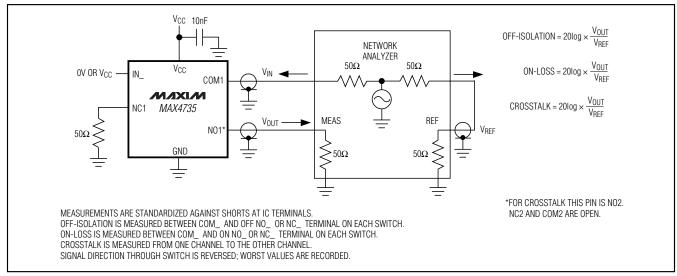


Figure 3. Charge Injection



#### \_Timing Circuits/Timing Diagrams (continued)

Figure 4. On-Loss, Off-Isolation, and Crosstalk

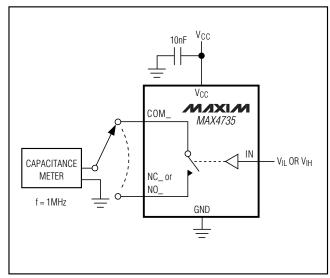
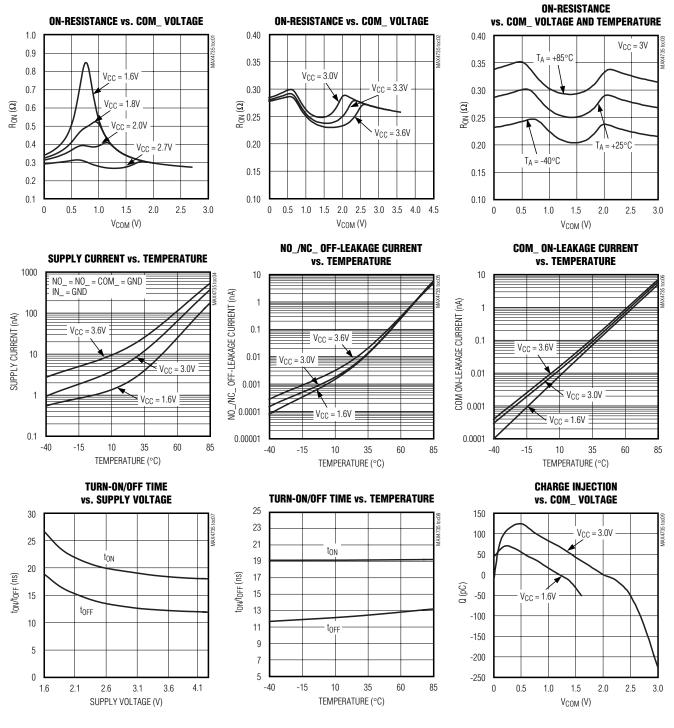


Figure 5. Channel On-/Off-Capacitance

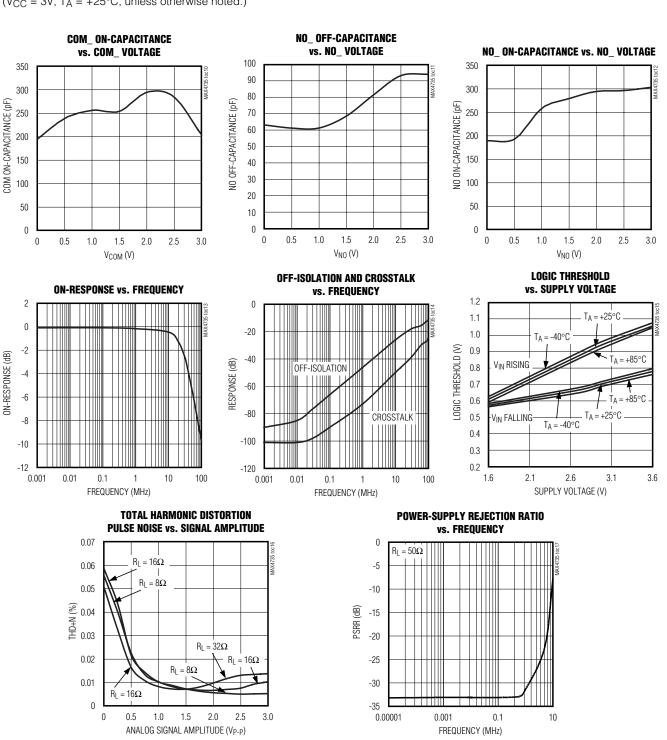
# **MAX4735**

 $(V_{CC} = 3V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

#### **Typical Operating Characteristics**



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#### **Typical Operating Characteristics (continued)**

 $(V_{CC} = 3V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

**MAX4735** 

**Pin Description** 

PI	N	NAME	FUNCTION				
TSSOP	TQFN		FUNCTION				
1	15	INA	Select Input A. Controls switch 1 and switch 2.				
2	16	NC1	Normally Closed Terminal Switch 1				
3	1	COM1	Common Terminal Switch 1				
4	2	NO1	Normally Open Terminal Switch 1				
5	3	NC2	Normally Closed Terminal Switch 2				
6	4	COM2	Common Terminal Switch 2				
7	5	NO2	Normally Open Terminal Switch 2				
8	6	GND	Ground				
9	7	INB	Select Input B. Controls switch 3 and switch 4.				
10	8	NO3	Normally Open Terminal Switch 3				
11	9	COM3	Common Terminal Switch 3				
12	10	NC3	Normally Closed Terminal Switch 3				
13	11	NO4	Normally Open Terminal Switch 4				
14	12	COM4	Common Terminal Switch 4				
15	13	NC4	Normally Closed Terminal Switch 4	Normally Closed Terminal Switch 4			
16	14	Vcc	Positive Power Supply				
_	PAD	EP	Exposed Pad. Connect to GND.				

#### **Detailed Description**

The MAX4735 quad-SPDT analog switch operates from a single +1.6V to +3.6V supply. These devices are fully specified for +3V applications.

The MAX4735 features fully bidirectional, rail-to-rail CMOS analog switch channels. They can be configured as dual-DPDT switches, dual 4:2 multiplexers/demultiplexers, or as a single 8:4 multiplexer/demultiplexer. See Figure 6.

#### \_Applications Information

#### **Analog Signal Range**

The CMOS switches in the MAX4735 function on any signal within the power-supply voltages. If any channel exceeds V<sub>CC</sub>, it is clamped to V<sub>CC</sub> by a silicon diode. If any channel goes below GND, it is clamped to GND by a silicon diode. Ensure that if either of these diodes becomes forward biased, the continuous and peak currents do not exceed those listed in the *Absolute Maximum Ratings* section of this data sheet.

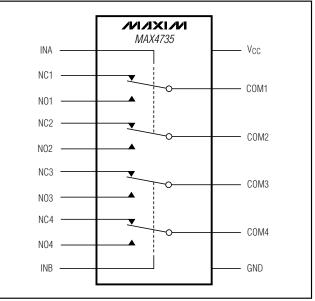


Figure 6. Functional Diagram

As seen in the *Typical Operating Characteristics*, the on-resistance of the MAX4735 is inversely proportional to the supply voltage. Best performance is obtained by using the highest supply voltage available within the +1.6V to +3.6V range.

#### **Digital Logic Inputs**

Digital control inputs INA and INB control the position of the switches in the MAX4735. These inputs are diode clamped to GND only. It is acceptable to leave these pins driven in the absence of a V<sub>CC</sub> power supply.

For best performance, drive INA and INB to the full supply voltage range of the MAX4735.

The two switch sections of the MAX4735 operate independently. Drive INA low to connect COM1 to NC1 and connect COM2 to NC2. Drive INA high to connect COM1 to NO1 and connect COM2 to NO2. Drive INB low to connect COM3 to NC3 and connect COM4 to NC4. Drive INB high to connect COM3 to NO3 and connect COM4 to NO4. See Table 1.

INA and INB have typical hystersis of 100mV by including positive feedback in the internal buffer. Thus, for applications using DC or very slow ramp rate of the digital input voltage level, connect a 100pF capacitor from IN\_ to GND to limit the I<sub>CC</sub> current at the trip point. The switching point is typically 0.7V between V<sub>IL</sub> and V<sub>IH</sub> levels.

#### **Power Supply**

The MAX4735 operates from a  $\pm$ 1.6V to  $\pm$ 3.6V power supply. For best results, bypass V<sub>CC</sub> to GND with a 0.1µF ceramic chip capacitor located close to the IC.

#### **Audio Signal Routing**

The MAX4735's low R<sub>ON</sub> makes it an excellent choice for multiplexing loudspeakers in portable equipment. THD performance is inversely proportional to load impedance. Within the audio signal range, there is no frequency component to THD. The only distortion mechanism is the R<sub>ON</sub> flatness' modulation of the signal into a load. Therefore, for best distortion performance, use higher impedance transducers.

#### Table 1. Truth Table

INA	INB	SWITCH 1 AND SWITCH 2 STATE	SWITCH 3 AND SWITCH 4 STATE
0	_	COM1 to NC1 COM2 to NC2	_
1	_	COM1 to NO1 COM2 to NO2	_
_	0	_	COM3 to NC3 COM4 to NC4
_	1	_	COM3 to NO3 COM4 to NO4

Each switch channel on the MAX4735 has an absolute maximum rating 300mA continuous current, and 400mA peak current at 50% duty cycle. When driving low-impedance loudspeakers, the peak signal amplitude should be limited so these peak currents are not exceeded. For an 8 $\Omega$  load, this corresponds to 2.3VRMS. For a 4 $\Omega$  load, this is 1.1VRMS.

#### **Package Information**

The MAX4735 is offered in 16-pin TSSOP and 3mm x 3mm x 0.8mm TQFN packages. The mechanical drawings for these packages are located at the end of this data sheet. Please check www.maxim-ic.com/packages to ensure working with the latest information.

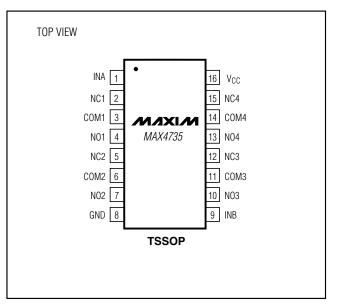
The TSSOP package is rated for a peak power dissipation of 755mW at +70°C, with a  $\theta_{JA}$  of 106°C/W on a single-layer PC board. The TQFN package is rated for a peak power dissipation of 1.25W at +70°C, with a  $\theta_{JA}$ of 64°C/W on a single-layer PC board. The TQFN package is the T1633-4 package code variant.



**Chip Information** 

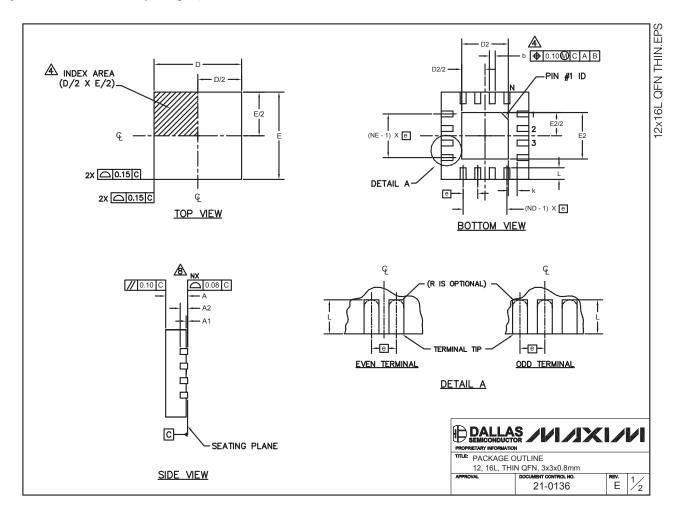
TRANSISTOR COUNT: 487 PROCESS: CMOS

#### \_Pin Configurations (continued)



#### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



#### **Package Information (continued)**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

PKG		12L 3x3		16L 3x3			
REF.	MIN. NOM.		MAX.	MIN.	NOM.	MAX.	
А	0.70	0.75	0.80	0.70	0.75	0.80	
b	0.20	0.25	0.30	0.20	0.25	0.30	
D	2.90	3.00	3.10	2.90	3.00	3.10	
Е	2.90	3.00	3.10	2.90	3.00	3.10	
е		0.50 BSC		0.50 BSC.			
L	0.45	0.55	0.65	0.30	0.40	0.50	
Ν		12		16			
ND		3		4			
NE		3		4			
A1	0	0.02	0.05	0	0.02	0.05	
A2		0.20 REF			0.20 REF		
k	0.25	-	-	0.25	-	-	

EXPOSED PAD VARIATIONS									
PKG. CODES	D2 E2				D2		PIN ID	JEDEC	DOWN BONDS
CODES	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		ULDLO	ALLOWED
T1233-1	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45∞	WEED-1	NO
T1233-3	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45∞	WEED-1	YES
T1633-1	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45∞	WEED-2	NO
T1633-2	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45∞	WEED-2	YES
T1633F-3	0.65	0.80	0.95	0.65	0.80	0.95	0.225 x 45∞	WEED-2	N/A
T1633-4	0.95	1.10	1.25	0.95	1.10	1.25	0.35 x 45∞	WEED-2	NO

#### NOTES:

1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.

2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.

3. N IS THE TOTAL NUMBER OF TERMINALS.

THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.

- ▲ DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.20 mm AND 0.25 mm FROM TERMINAL TIP.
- AND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- 7. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- 9. DRAWING CONFORMS TO JEDEC MO220 REVISION C.

BALLAS //////////

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ETARY INFORMATION

PACKAGE OUTLINE 12, 16L, THIN QFN, 3x3x0.8mm

DOCUM

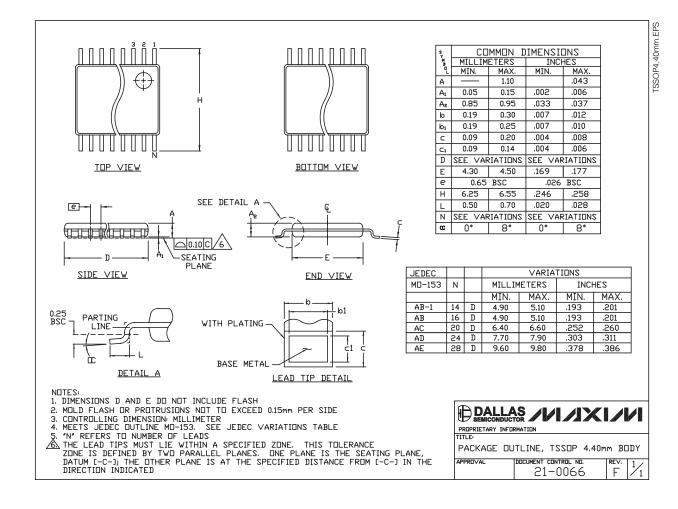
TITLE:

APPROVAL

E 2/2

#### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>www.maxim-ic.com/packages</u>.)



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